EPISTAR

ES-FFBCPE04J

InGaN Blue LED Chip

> Mechanical Specification:

(1) Dimension

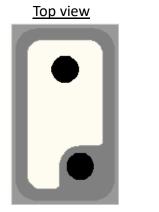
- Chip size: 4mil x 6mil (89 \pm 15 μm x 150 \pm 15 $\mu m)$

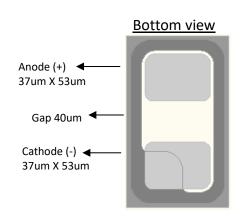
- Thickness: 3.1mil (80 \pm 10 μ m)

- Anode pad: 37 \pm 10 μm x 53 \pm 10 μm - Cathode pad: 37 \pm 10 μm x 53 \pm 10 μm

(2) Metallization

- Electrode pad: Au





Features:

- High Power Density
- Low Rth and Long life time

Applications:

· Fine Pitch Display

> Electro-optical Characteristics at 25°C(1):

| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
|------------------------------------|--------|-----------|------|------|------|------|
| Forward Voltage | Vf1 | If = 10μA | 1.9 | - | - | V |
| | Vf2 | If = 1mA | - | 2.6 | 2.9 | V |
| Reverse Current | Ir | Vr = 10V | - | - | 0.5 | uA |
| Dominant Wavelength ⁽²⁾ | λd | If = 1mA | 465 | - | 475 | nm |
| Spectra Half-width | Δλ | If = 1mA | - | 17 | - | nm |
| Luminous intensity ⁽³⁾ | lv | If = 1mA | 12.5 | | 14.0 | mcd |
| | | | 14.0 | | 15.5 | |
| | | | 15.5 | | 17.0 | |
| | | | 17.0 | | 19.0 | |
| | | | 19.0 | | 21.0 | |

Note:

⁽¹⁾ ESD protection during chip handling is recommended.

⁽²⁾ Basically, the wavelength span is 10nm; however, customers' special requirements are also welcome.

⁽³⁾ Luminous intensity is measured by EPISTAR's equipment on bare chips.

> Absolute Maximum Ratings:

| Parameter | Symbol | Condition | Rating | Unit |
|------------------------------|--------|-----------------------------|-------------|------|
| Forward DC Current | If | Ta = 25℃ | ≤ 5 | mA |
| Reverse Voltage | Vr | Ta = 25℃ | ≤ 10 | V |
| Junction Temperature | Tj | - | ≤ 115 | C |
| | Tstg | Chip | -40 ~ +85 | ٥ |
| Storage Temperature | | Chip-on-tape/storage | 5 ~ 35 | ٥ |
| | | Chip-on-tape/transportation | -20 ~ +65 | C |
| Temperature during Packaging | - | - | 260(<5sec)* | C |

Note: Maximum ratings are package dependent. The above maximum ratings were determined using by EPISTAR standard. Forward current and junction temperature will cause the damage of LEDs if over the absolute maximum ratings.

*Reflow soldering should not be done more than two times.

> Characteristic Curves:

Fig.1 - Relative luminous Intensity vs. Forward Current

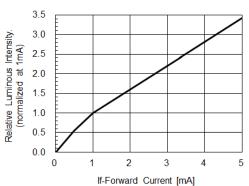


Fig.3 - Relative Intensity (@1mA) vs. Ambient Temperature

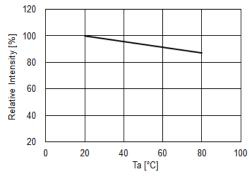


Fig.5 - Dominant Wavelength (@1mA) vs. Ambient Temperature

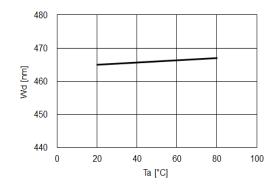


Fig.2 - Forward Current vs. Forward Voltage

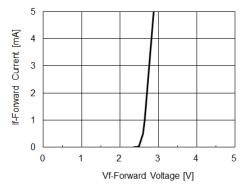


Fig.4 - Forward Voltage (@1mA) vs. Ambient Temperature

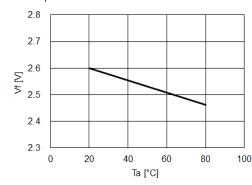


Fig.6 – Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on Tj max. = 115°C)

